Declaration for U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled (Insert Title) INSPECTION METHOD AND INSPECTION SYSTEM OF A TERMINAL METAL FITTING the specification of which is attached hereto unless the following is checked

the specificatio	n of which is attached hereto unless	s the following is c	hecked	
	was filed on and	as United States was amended on	Application Number or PCT I	nternational Application Number _ applicable).
I hereby state the amended by any	hat I have reviewed and understand y amendment referred to above.	the contents of the	above-identified specification	, including the claim(s), as
Regulations, §				
or fisentor's ce	foreign priority benefits under Title ertificate listed below and have also	identified below a	Code, § 119 (a) - (d) of any f	oreign application(s) for patent
having a filing of	date before that of the application f	or which priority is	s claimed:	nt or inventor's certificate
UT				Priority Claimed
(List prior	2000-296332	Japan /	28/09/2000	_X_Yes No
foreign	(Number)	(Country)	(Day/Month/Year Filed)	
applications.				Yes No
See note A on	(Number)	(Country)	(Day/Month/Year Filed)	
back of this			(- 7	Yes No
page)	(Number)	(Country)	(Day/Month/Year Filed)	
Lak				Yes No

(See note B on back of this page)

(Number)

_ See attached list for additional prior foreign applications

(Day/Month/Year Filed)

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Country)

(List Prior U.S.			
Applications)	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)
	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)
	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C	Full name of sole or first inventor (given name, family name) TATSUYA MAEDA				
above)					
• 1	Inventor's signature hotsup (malda Date September 25, 2001				
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Full name of second is	nventor (given name, family name)				
nventor's signature Date					
Residence	Citizenship				
Post Office Address _					
Full hame of third inv	entor (given name, family name)				
Inventor's signature Date					
Residence	Citizenship				
Post Office Address _					
Full name of fourth in	ventor (given name, family name)				
Inventor's signature _	Date				
Residence	Citizenship				
Post Office Address _					
	entor (given name, family name)				
Inventor's signature _	Date				
Residence	Citizenship				
Post Office Address _					
Full name of sixth inv	entor (given name, family name)				
Inventor's signature _	Date				
	Citizenship				
Post Office Address _					
Full name of seventh	nventor (given name, family name)				
Inventor's signature _	Date				
Residence	Citizenship				
Post Office Address _					
	ventor (given name, family name)				
	Date				
Residence	Citizenship				
Post Office Address _					